

Product Description

Modified epoxy | 1 part | solvent-free | heat-curing

- Filter bonding
- Automotive
- Aerospace

- Short curing times at low temperatures
- Very good oil resistance

Curing Properties

This adhesive must be cured with heat. Typical curing temperatures are listed in the table below.

Temperatures	Time
100°C	15 min
150°C	5 min

The heat cure times are only provided as a guideline. They are derived from curing a 2g adhesive sample without affixed substrates in a laboratory environment. Actual cure times can vary based on part size, configuration, adhesive volume, temperature control, and the time required for the component substrates to attain oven temperature.

The final bond strength of the adhesive is achieved no sooner than 24 h after the bonded components are removed from the oven.



Technical Data

Resin	Ероху
Appearance	Beige
Filler	Chalk
Filler - weight [%]	40
Particle size D98 [µm]	12.5

Uncured Material	
Viscosity [mPas] (Kinexus Rheometer, 25 °C, 1s ⁻¹)	100,000 - 150,000
PE-Norm 064	100,000 100,000
Viscosity [mPas] (Kinexus Rheometer, 25 °C, 10s ⁻¹)	32,000 - 50,000
PE-Norm 064	
Density [g/cm ³]	1.6 – 1.7
PE-Norm 004	
Cured Material	
Hardness shore D	
150°C, 20min	75 – 90
PE-Norm 006	
Shrinkage [%]	
150°C, 20min	< 1
PE-Norm 031	
Water absorption [%] 150°C, 20min	< 1
PE-Norm 016	
Glass transition temperature - DSC [°C]	400 400
150°C, 20min	100 – 120
PE-Norm 009	
Coefficient of thermal expansion [ppm/K] below Tg 150°C, 20min	30 – 50
PE-Norm 017	50 50
Coefficient of thermal expansion [ppm/K] above Tg	
150°C, 20min	130 – 160
PE-Norm 017	
Voung's modulus - Tonsilo tost [MDa]	
Young's modulus – Tensile test [MPa] 150°C, 20min	5,000 - 8,500
PE-Norm 056	5,000 - 8,500
Tensile strength [MPa]	
150°C, 20min	20 – 35
PE-Norm 014	20 33
Elongation at break [%]	
150°C, 20min	< 1
PE-Norm 014	
Lap shear strength (steel/steel) [MPa]	
130°C, 20min	12 – 13
PE-Norm 013	



Lap shear strength (steel/steel) [MPa]	
130°C, 20min	16 – 18
Sandblasted, RT	10-18
PE-Norm 013	

Transport/Storage/Shelf Life

Package type	Transport	Storage	Shelf life*
Syringe/Cartridge	0°C – 10°C	0°C – 10°C	At delivery min. 3 months max. 6 months
Other packages			

*Store in original, unopened containers!

Instructions for use

Surface preparation

The surfaces to be bonded should be free of dust, oil, grease, mold release, or other contaminants in order to obtain an optimal and reproducible bond. For cleaning we recommend the cleaner IP[®] from Panacol, or a solution of Isopropyl Alcohol at 90% or higher concentration. Substrates with low surface energy (e.g. polyethylene, polypropylene) must be pretreated in order to achieve sufficient adhesion.

Application

Our products are supplied ready to use. Depending on packaging they can be applied by hand directly from the container or by using compatible dispensing systems and automation. Many commercially available valve and controller options are available to ensure accurate and consistent adhesive dispensing. For assistance with dispensing and curing questions, please contact our Applications Engineering department. To obtain best results, the adhesive and substrates to be bonded may not be cold and should be allowed to warm to room temperature prior to processing. For safety information refer to our Material Safety Data Sheet (MSDS).

Storage

Store uncured product in its original, closed container in a dry location. Any material removed from the original container must not be returned to the container as it could be contaminated. Panacol cannot assume responsibility for products that were improperly stored, contaminated, or repackaged into other containers.

Handling and Clean-up

For safe handling information, consult this product's Material Safety Data Sheet (MSDS) prior to use. Uncured material may be wiped away from surfaces with organic solvents. Do not use solvents to remove material from eyes or skin!



Disclaimer

The product is free of heavy metals, PFOS and Phthalates and is conform to the current EU-Directive RoHS.

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